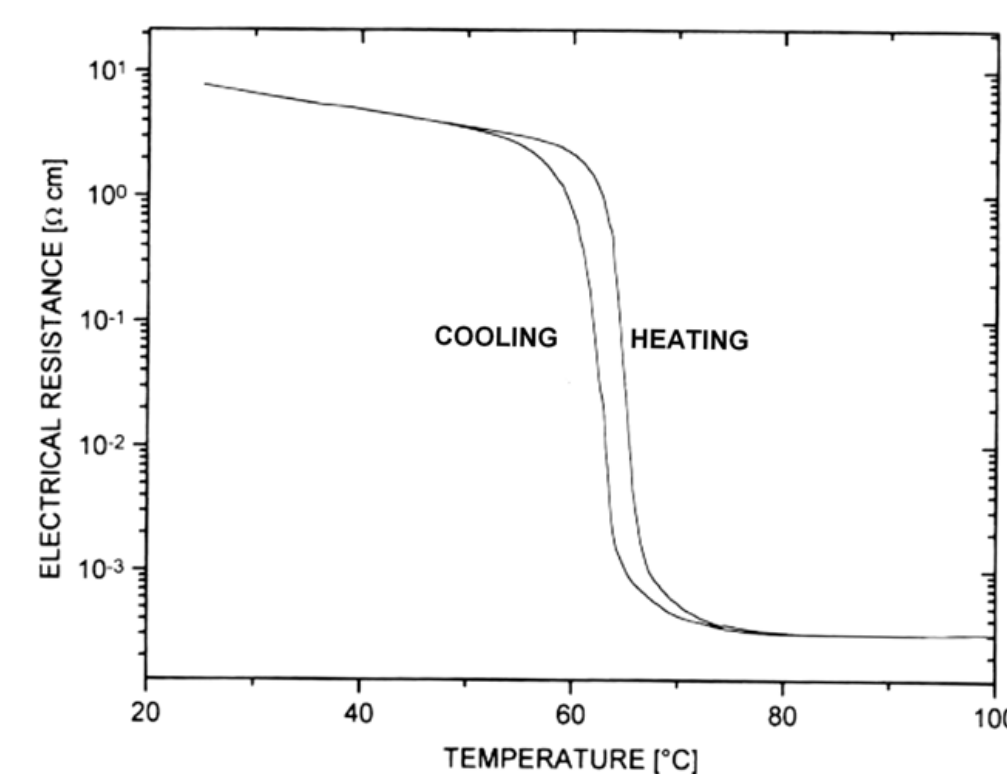


Introduction

VO₂ is a transition-metal oxide, a class of materials comprised of transition metals and oxygen that often shows either insulating or conducting phases. VO₂ undergoes a sharp metal-insulator (MI) transition at around 350 K, with thermal hysteresis.

Electrical Resistance vs. Temperature of VO₂

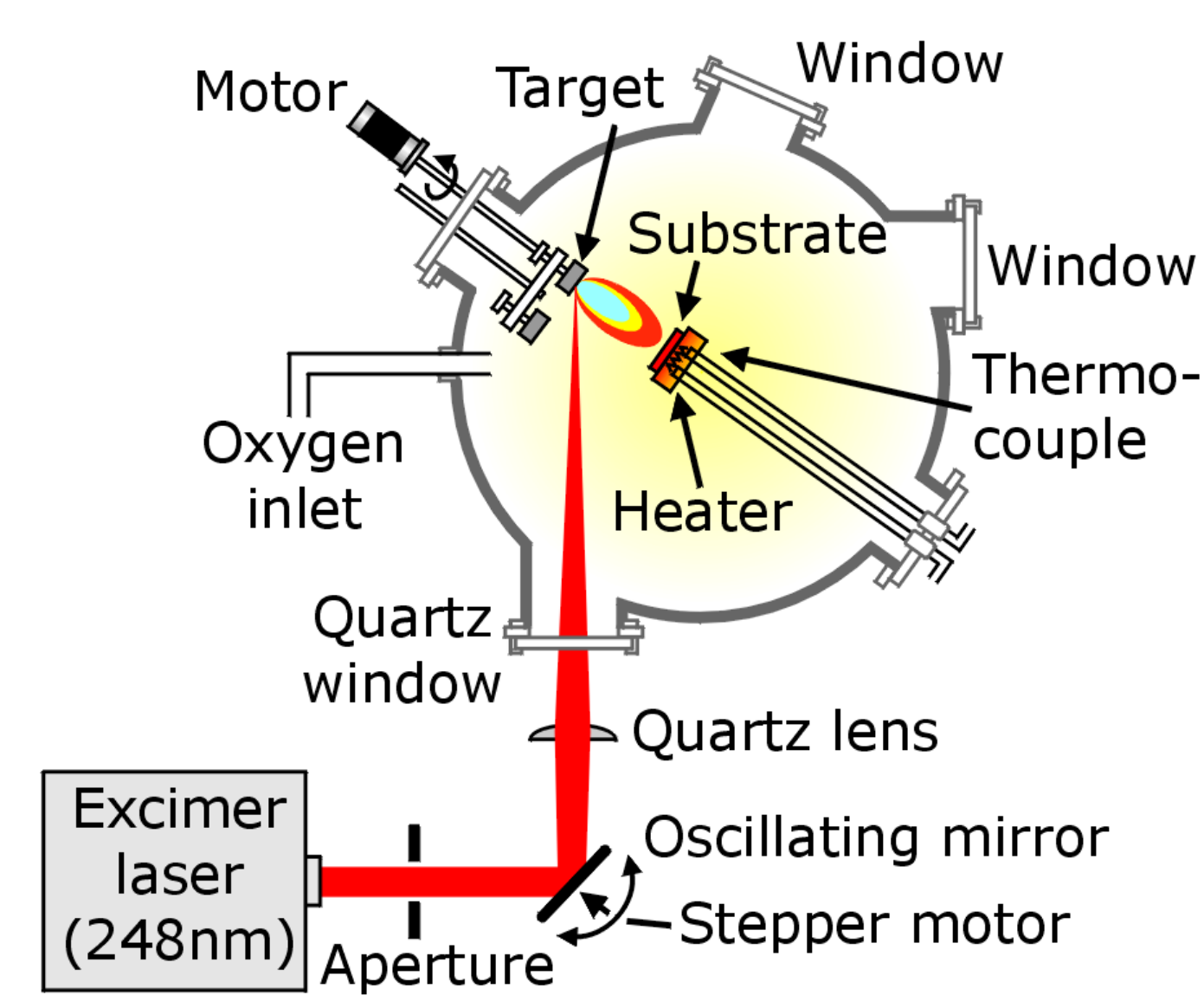


[J.Nag et. al. J. Phys. Condens. Matter. 20 266416(2008)]

There are many applications to the MI transition such as information technology, smart materials, and sensors. Since there are strong interplays between lattice, charge, orbital degrees of freedom in strongly correlated VO₂, the MI transition is easily tuned by carrier doping, such as hydrogen insertion (hydrogenation). It has been shown that hydrogenation in VO₂ nanobeams can control the MI transition [H. Zhou et. al. Journal of Applied Physics. 110 073514(2011)]. However, the work has not been done on VO₂ films. Here, we present the hydrogenation study on VO₂ films for the first time.

Material and Methods

Schematic Diagram of PLD System



[physics.colorstate.edu]

- VO₂ film grown on Al₂O₃ substrate using pulsed laser deposition method (PLD)
- O₂ pressure: 10mTorr
- Thickness of film=80nm
- Cool down rate= 20K/min, in 10mTorr of O₂.
- Substrate temperature: 600°C
- Target:V₂O₅ polycrystalline.

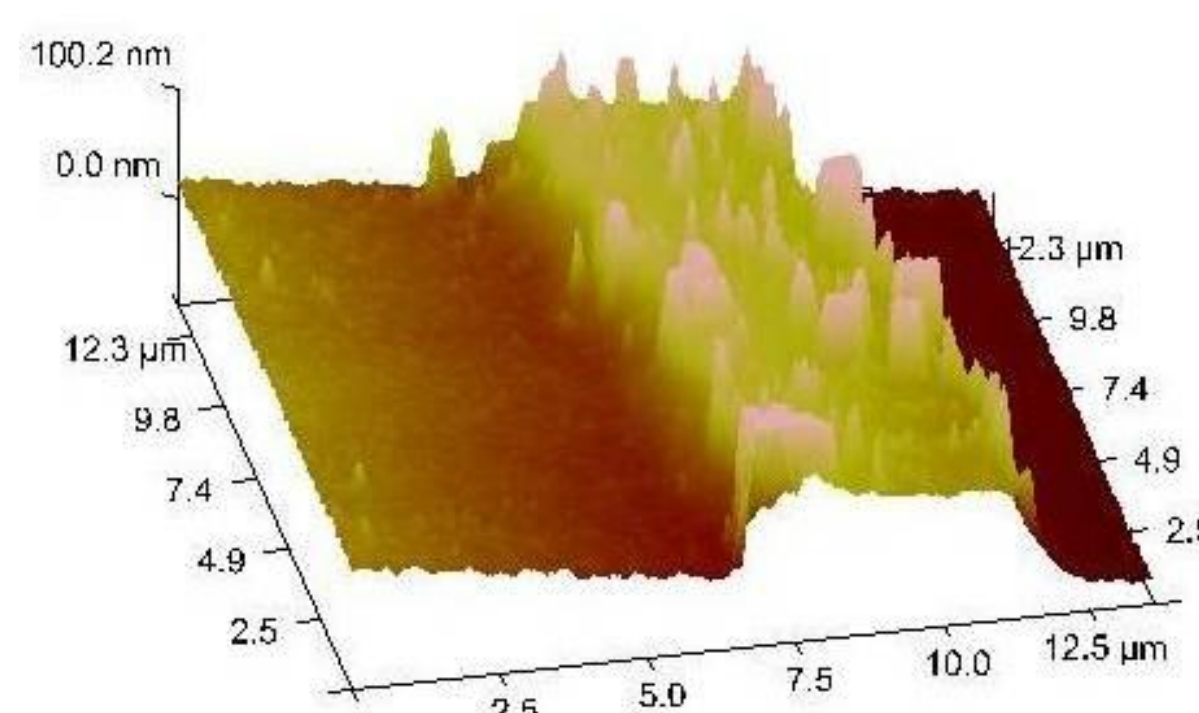
Film Patterning



Microscopic Image of VO₂ Wire Structure

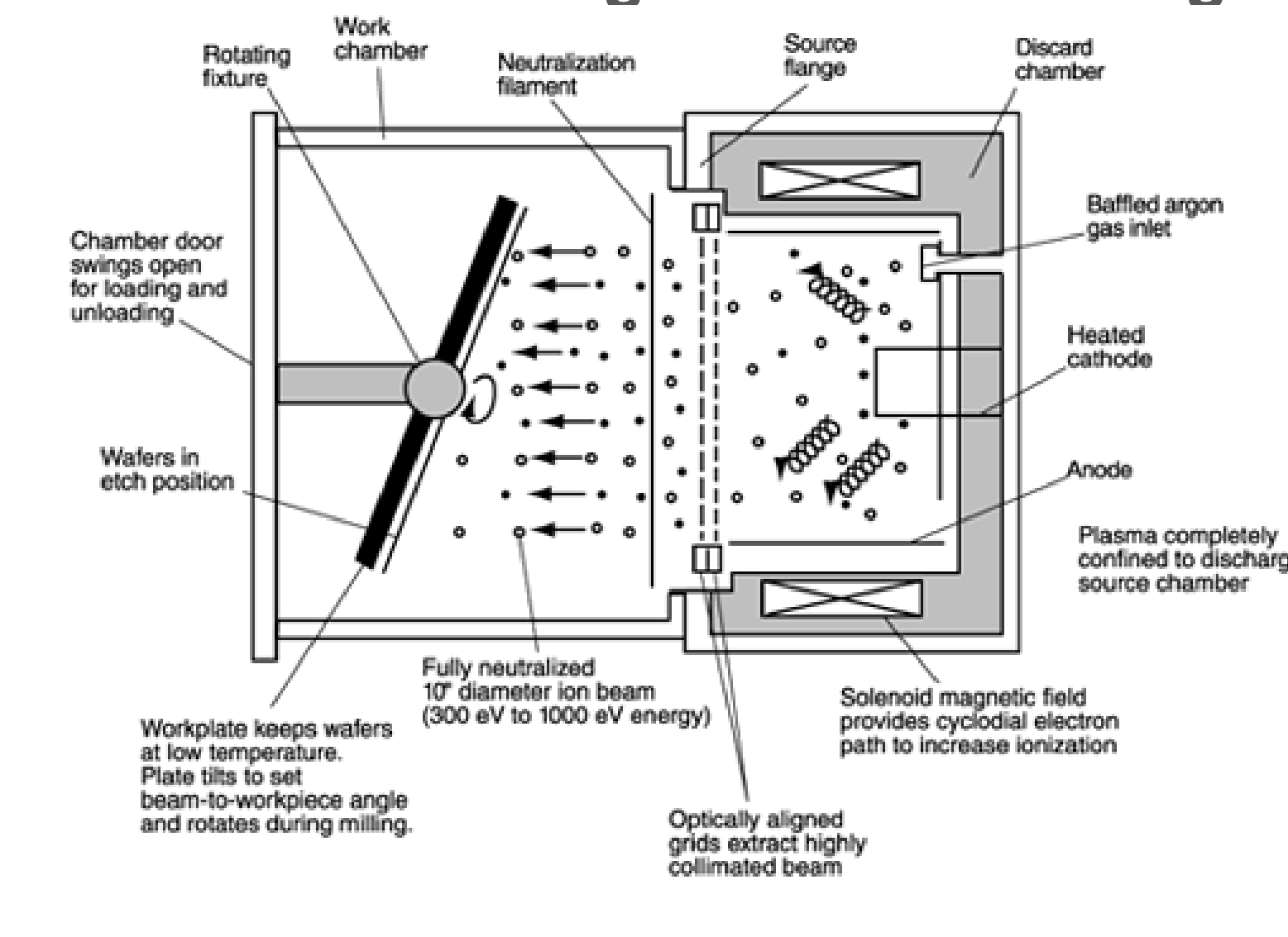
photoresist is applied to the films, then spin-coated to create an even layer of around 5 μm, then exposed to UV light in a mask aligner.

AFM Image of VO₂ Wire Structure



Methods and Materials

Schematic Diagram of Ion Milling



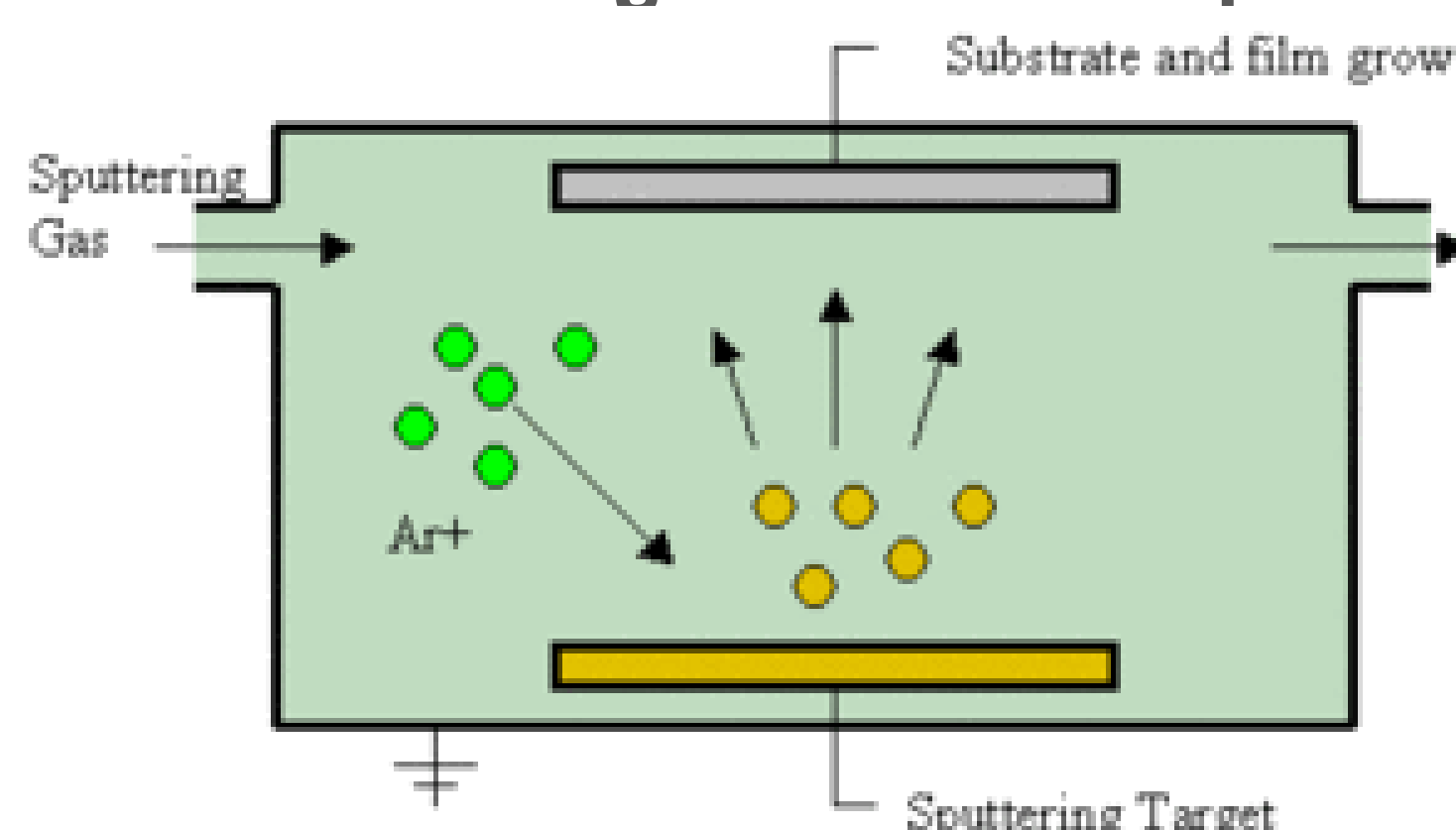
[ionbeammilling.com]

Photoresist protects the active area while the rest of the film is etched away by an beam of argon ions.

Electrode preparation

•A second mask aligning was used to place gold pads on top of VO₂ wire.

Schematic Diagram of Gold Sputtering



[http://en.wikipedia.org/wiki/Sputter_deposition]

•Photoresist covers everywhere but the gold pads. Gold is applied to the entire film and later lifted-off everywhere but the gold pads.

Hydrogenation

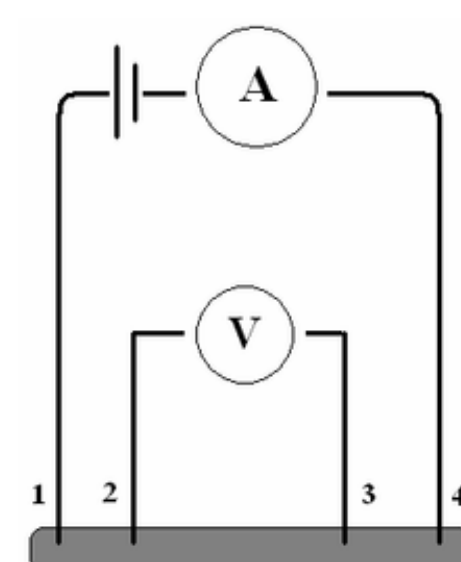
- Sample annealed in Mixed gas with 5% H₂+95%He, 1 atm, 1 day, in a tube furnace.
- Sample annealed at the various temperatures: 200°C, 300°C.

Resistivity Measurement

•Resistivity of the film measured by four-probe method in a Physical Property Measurement System (PPMS)

•The IV curve was measured using the four-probe method by a 1-K insert.

Schematic Diagram of Four-Probe Method

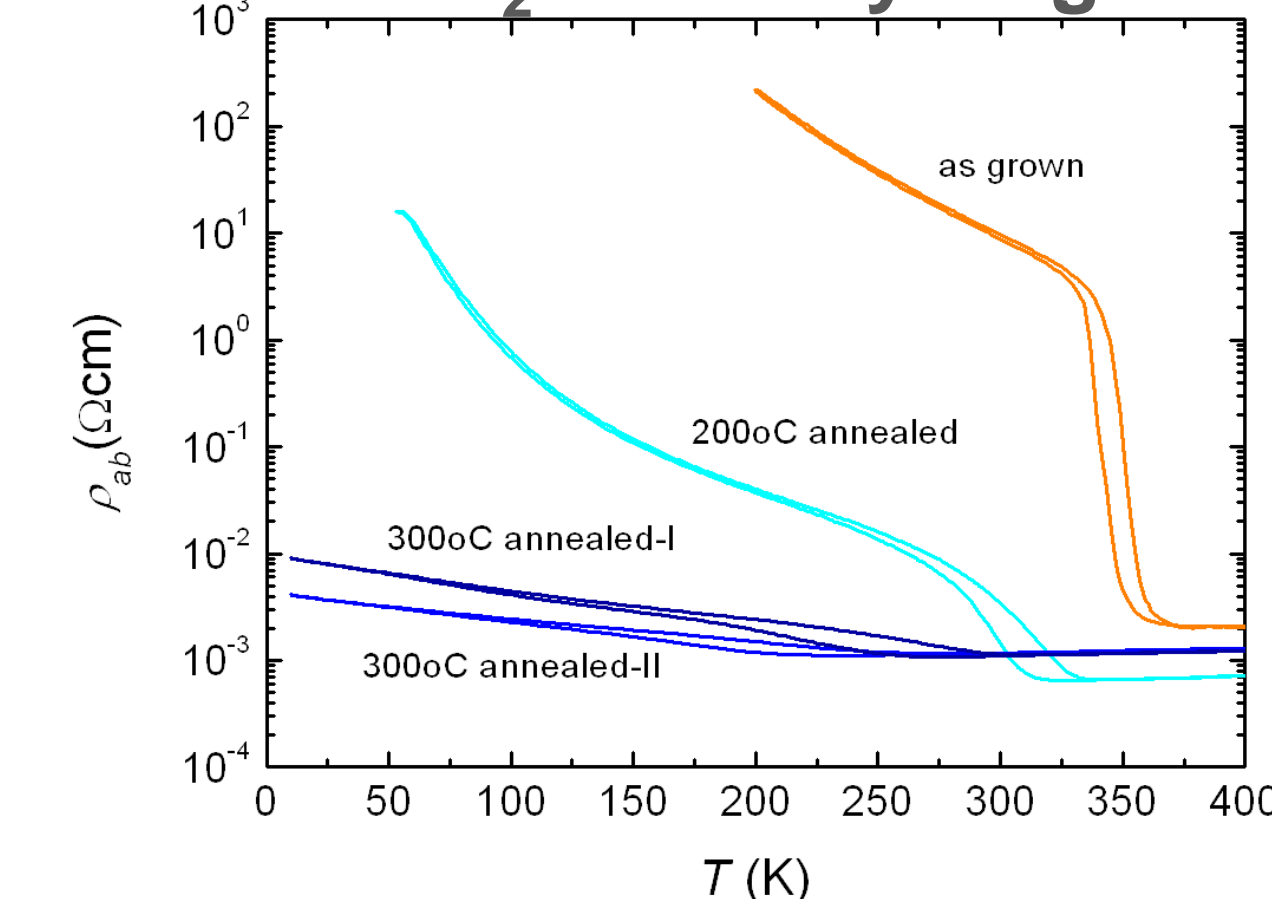


Uses separate pairs of current carrying and voltage measuring wires to make a more accurate reading than the traditional two-probe method

[http://en.wikipedia.org/wiki/Four-terminal_sensing]

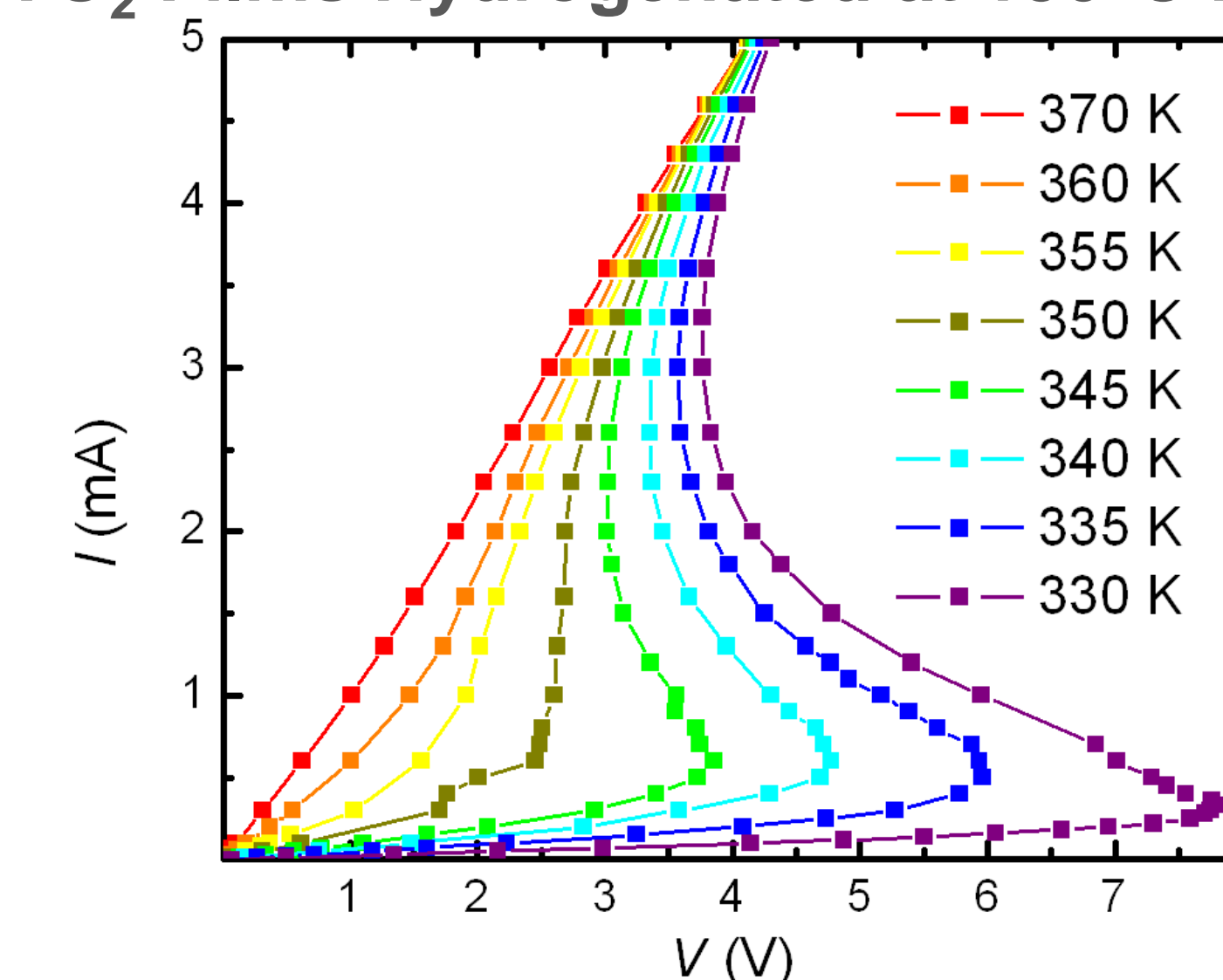
Results

Resistivity vs. Temperature of VO₂ Films Hydrogenated in a Tube Furnace



- Transition temperatures are decreased with increasing hydrogenation temperatures.
- MI transition is suppressed with increasing hydrogenation temperatures.

IV Plot of VO₂ Films Hydrogenated at 150°C for 1 day at 1 atm



- Sharp change of IV slope indicates current-induced MI transition through heating effect.
- Critical current I_c is as small as 0.3 mA.

Conclusions

- We succeeded in growing VO₂ thin film on a Al₂O₃ substrate with (0001) orientation and fabricated a VO₂ wire with a width of 5 μm.
- Metal-insulator transition of VO₂ wires is suppressed with increasing hydrogenation temperatures.
- We observed current induced metal-insulator transition with critical current as small as 0.3 mA in IV curves.

Acknowledgements

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